

STY100NM60N

N-channel 600 V, 0.028 Ω typ., 98 A MDmesh™ II Power MOSFET in a Max247 package

Datasheet — production data

Features

Туре	V _{DSS} @ T _{Jmax}	R _{DS(on)} max	I _D
STY100NM60N	650 V	< 0.029 Ω	98 A

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

Applications

Switching applications

Description

This device is an N-channel Power MOSFET developed using the second generation of MDmesh™ technology. This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

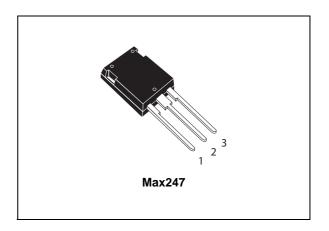


Figure 1. Internal schematic diagram

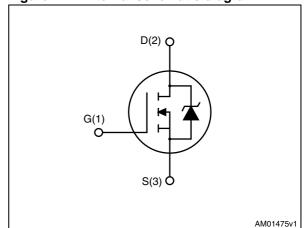


Table 1. Device summary

Order code	Marking	Package	Packaging
STY100NM60N	100NM60N	Max247	Tube

Contents STY100NM60N

Contents

1	Electrical ratings 3
2	Electrical characteristics4
	2.1 Electrical characteristics (curves)
3	Test circuits8
4	Package mechanical data 9
5	Revision history12

STY100NM60N Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{GS}	Gate- source voltage	25	V
I _D	Drain current (continuous) at T _C = 25 °C	98	Α
I _D	Drain current (continuous) at T _C = 100 °C	62	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	392	Α
P _{TOT}	Total dissipation at T _C = 25 °C	625	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope 15		V/ns
T _{stg}	Storage temperature - 55 to 150		°C
Tj	Max. operating junction temperature	- 55 (0 150	°C

^{1.} Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.2	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	30	°C/W
T _j	Maximum lead temperature for soldering purpose	300	°C

Table 4. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetetive or not repetetive (pulse width limited by T _{jmax})	15	Α
E _{AS}	Single pulse avalanche energy (starting T_j =25 °C, I_D = I_{ar} , V_{DD} =50)	757	mJ

^{2.} $I_{SD} \le 98 \text{ A}$, di/dt $\le 400 \text{ A/}\mu\text{s}$, V_{DS} peak $\le V_{(BR)DSS}$, $V_{DD} = 80\% \text{ V}_{(BR)DSS}$.

Electrical characteristics STY100NM60N

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified).

Table 5. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage (V _{GS} = 0)	I _D = 1 mA	600			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 600 V V _{DS} = 600 V, T _C =125 °C			10 150	μA μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 25 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 49 A		0.028	0.029	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 50 \text{ V, } f = 1 \text{ MHz,}$ $V_{GS} = 0$	-	9600 850 50	-	pF pF pF
C _{oss(eq)} ⁽¹⁾	Equivalent output capacitance	V _{DS} = 0 to 480 V V _{GS} = 0	-	1602	-	pF
R_{G}	Intrinsic gate resistance	f = 1 MHz open drain	-	1.3	-	Ω
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 480 \text{ V}, I_{D} = 98 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see <i>Figure 15</i>)	-	330 40 174	-	nC nC nC

C_{oss eq.} is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DS}

Table 7. Switching times

r							1
	Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
ĺ	t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 49 \text{ A},$		45		ns
	t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	_	52	_	ns
	$t_{d(off)}$	Turn-off delay time	(see Figure 16) and	_	372	_	ns
	t _f	Fall time	(see Figure 19)		81		ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)		-		98 392	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 98 A, V _{GS} = 0	-		1.6	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 98 A, di/dt = 100 A/µs V_{DD} = 60 V (see <i>Figure 16</i>)	-	622 16.5 52.5		ns µC A
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 98 \text{ A}, \text{ di/dt} = 100 \text{ A/µs}$ $V_{DD} = 60 \text{ V}, T_j = 150 ^{\circ}\text{C}$ (see <i>Figure 16</i>)	-	820 27 66		ns µC A

- 1. Pulse width limited by safe operating area.
- 2. Pulsed: pulse duration = $300 \mu s$, duty cycle 1.5%

Electrical characteristics STY100NM60N

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

100 AM15386v1
100 100 με 100

Figure 3. Thermal impedance

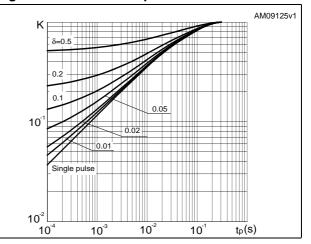


Figure 4. Output characteristics

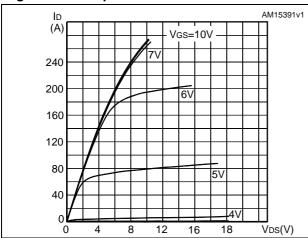


Figure 5. Transfer characteristics

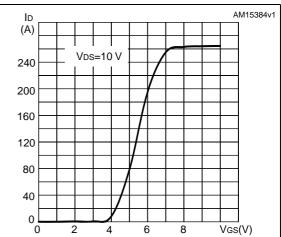
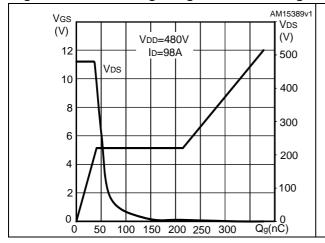


Figure 6. Gate charge vs gate-source voltage Figure 7. Static drain-source on-resistance



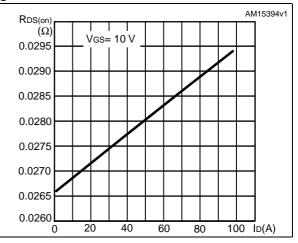
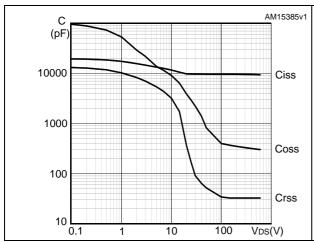


Figure 8. Capacitance variations

Figure 9. Normalized on-resistance vs temperature



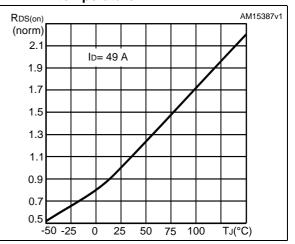
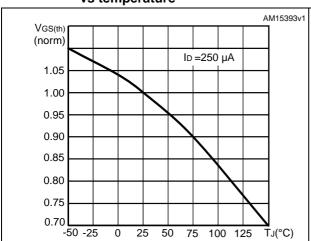


Figure 10. Normalized gate threshold voltage $\,$ Figure 11. Normalized $\,$ B $_{VDSS}$ vs temperature $\,$ vs temperature



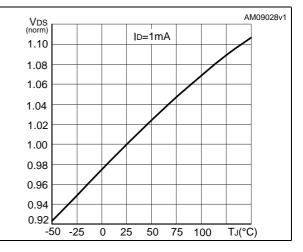
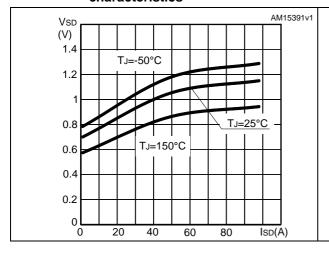
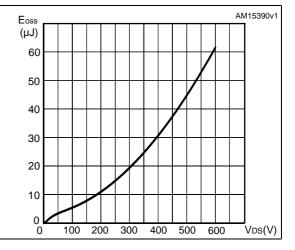


Figure 12. Source-drain diode forward characteristics

Figure 13. Output capacitance stored energy





Test circuits STY100NM60N

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

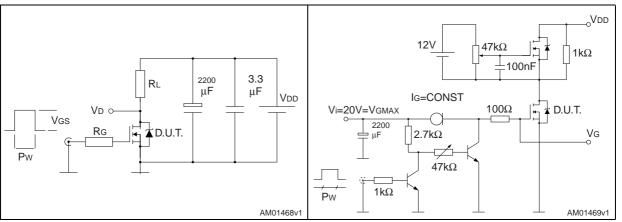


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

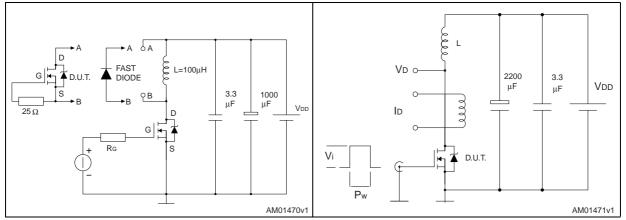
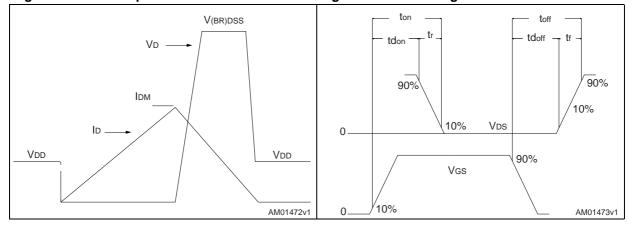


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



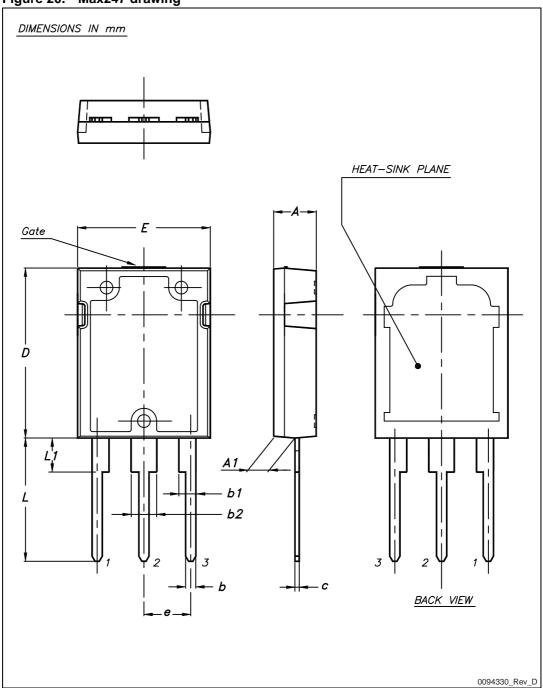
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK $^{\mathbb{B}}$ packages, depending on their level of environmental compliance. ECOPACK $^{\mathbb{B}}$ specifications, grade definitions and product status are available at: www.st.com. ECOPACK $^{\mathbb{B}}$ is an ST trademark.

Table 9. Max247 mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А	4.70		5.30
A1	2.20		2.60
b	1.00		1.40
b1	2.00		2.40
b2	3.00		3.40
С	0.40		0.80
D	19.70		20.30
е	5.35		5.55
E	15.30		15.90
L	14.20		15.20
L1	3.70		4.30

Figure 20. Max247 drawing



Revision history STY100NM60N

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
14-Sep-2011	1	First release.
05-Nov-2012	2	Document status promoted from preliminary to production data. Added Section 2.1: Electrical characteristics (curves). Minor text changes.

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